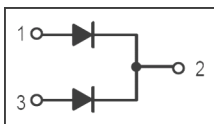


/ Descriptions

/ Features

/ Applications

/ Equivalent Circuit



/ Pinning



/ h_{FE} Classifications & Marking

/ Absolute Maximum Ratings(Ta=25)

	θ		
	θ		

/ Electrical Characteristics(Ta=25)

/ Electrical Characteristic Curve

Figure 1. Forward Current Derating Curve

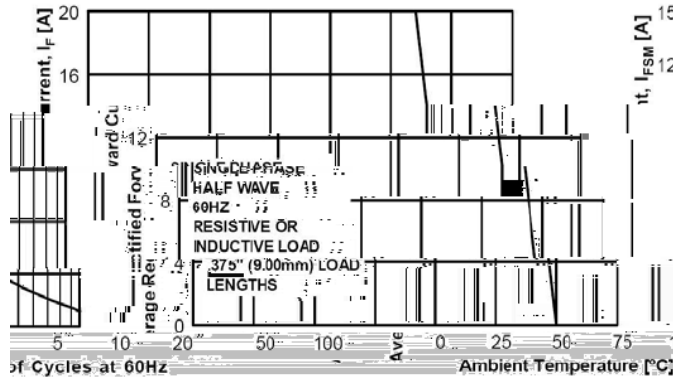


Figure 2. Non-Repetitive Surge Current

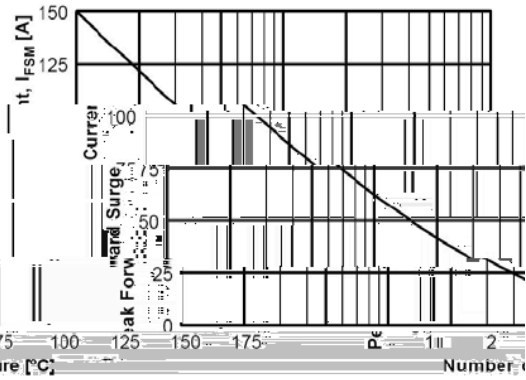


Figure 3. Forward Voltage Characteristics

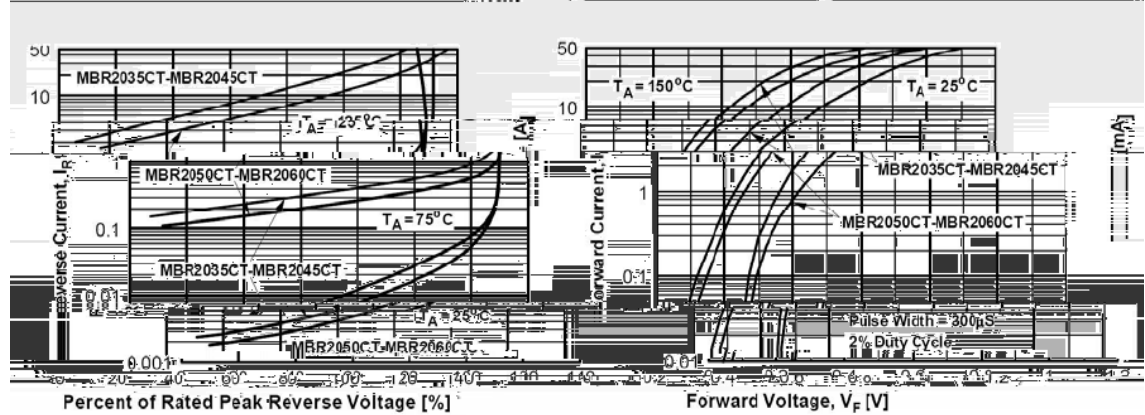


Figure 4. Reverse Voltage Characteristics

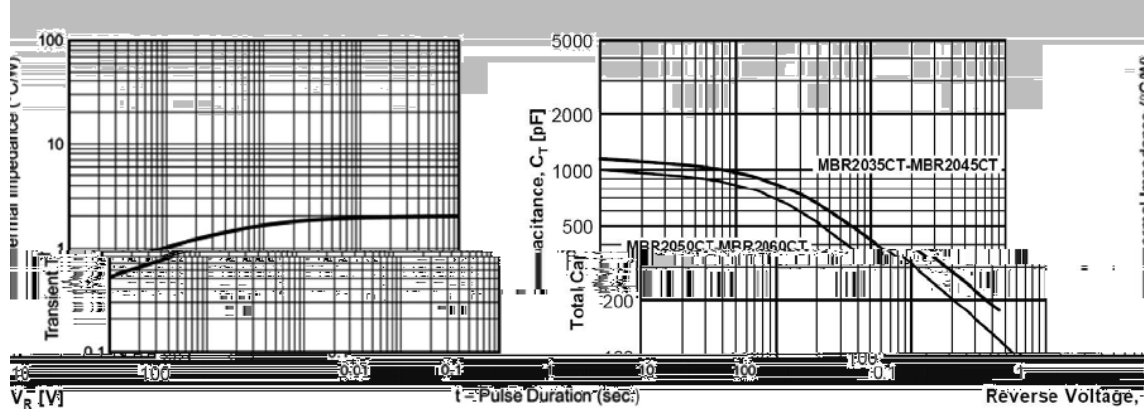
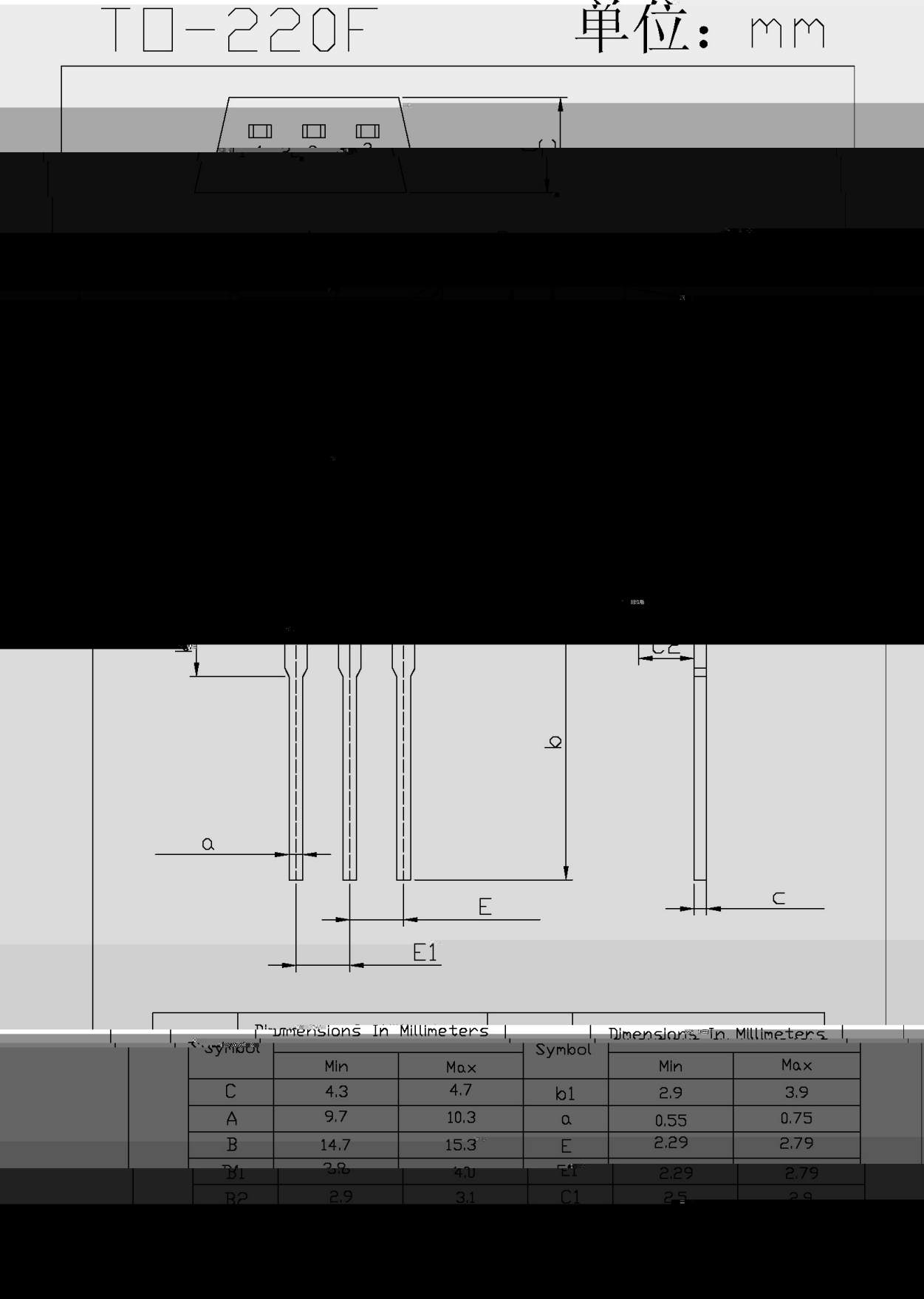


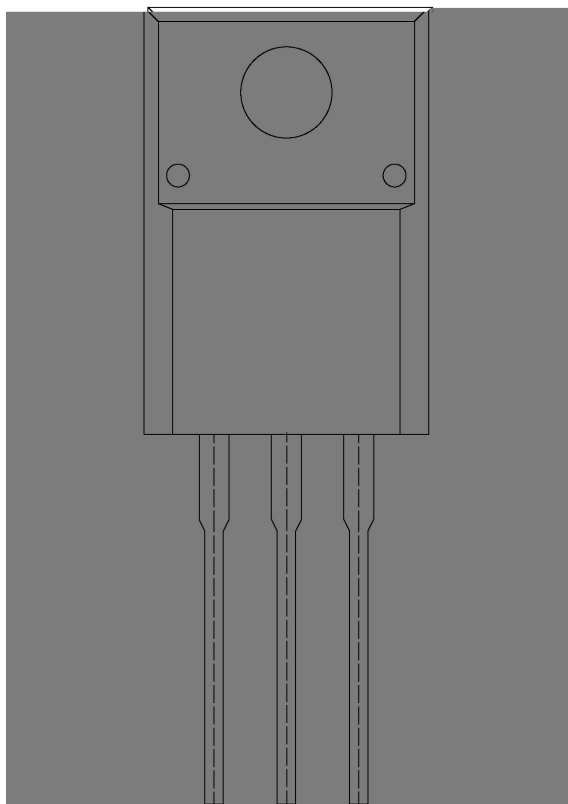
Figure 5. Thermal Impedance Characteristics



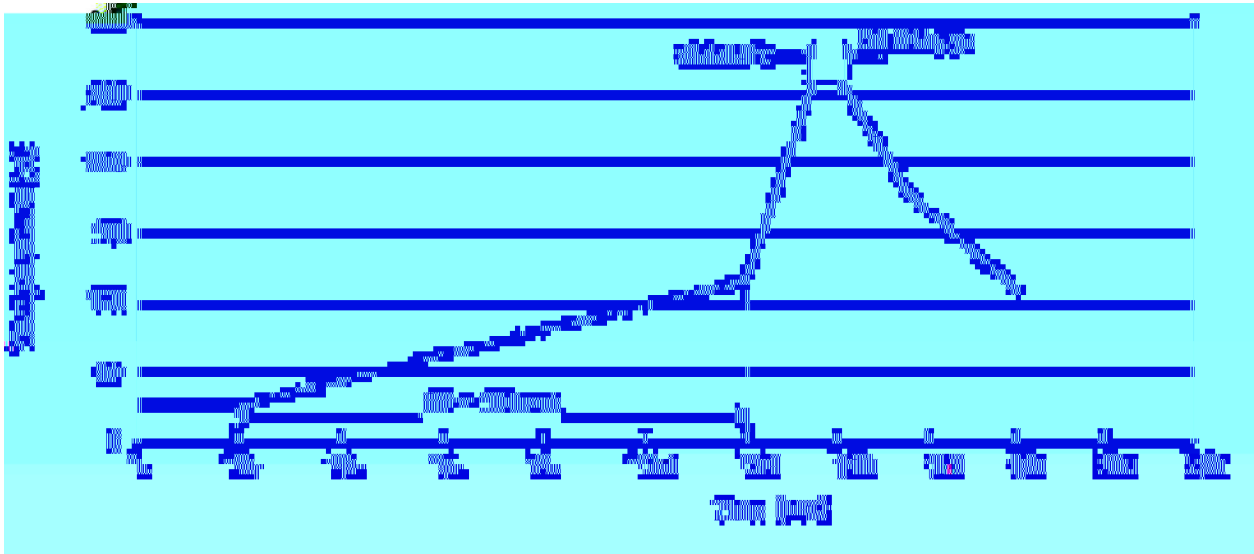
/ Package Dimensions



/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 袋	袋 盒	只 盒	盒 箱	只 箱	袋	盒	箱

封装形式	包装数量					包装尺寸		
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱

/ Notices